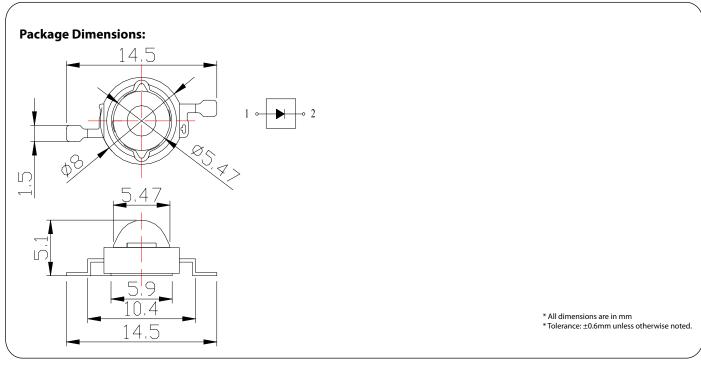
1W High Power LED







| | LEC | Lens Colour | |
|--------------|-------------|-----------------------------|-------------|
| Ant Part No. | Material | Material Colour Coordinates | |
| 703-0146 | InGaN/Al2O3 | True Green | Water clear |

Absolute Maximum Ratings at Ta=25°C:

| Parameter | Rating | Unit | |
|---|--|------|--|
| Power Dissipation | 1365 | mW | |
| LED Junction Temperature | 120 | °C | |
| Reverse Voltage | 5 | V | |
| D.C. Forward Current | 350 | mA | |
| Pulsed Forward Current; tp≤100μs, Duty Cycle=0.005)*1 | 700 | mA | |
| Operating Temperature Range | -40 to +75 | ℃ | |
| Storage Temperature Range | -40 to +100 | °C | |
| Soldering Temperature | Dip Soldering: 260°C for 10sec. Hand Soldering: 350°C for 3sec. | | |
| Electric Static Discharge Threshold (HBM) | 6000 | V | |

Important Notice: This data sheet and its contents (the "Information") belong to the members of the Premier Farnell group of companies (the "Group") or are licensed to it. No licence is granted for the use of it other than for information purposes in connection with the products to which it relates. No licence of any intellectual property rights is granted. The Information is subject to change without notice and replaces all data sheets previously supplied. The Information supplied is believed to be accurate but the Group assumes no responsibility for its accuracy or completeness, any error in or omission from it or for any use made of it. Users of this data sheet should check for themselves the Information and the suitability of the products for their purpose and not make any assumptions based on information included or omitted. Liability for loss or damage resulting from any reliance on the Information or use of it (including liability resulting from negligence or where the Group was aware of the possibility of such loss or damage arising) is excluded. This will not operate to limit or restrict the Group's liability for death or personal injury resulting from its negligence. Multicomp is the registered trademark of the Group. @ Premier Farnell plc 2011.

www.element14.com www.farnell.com www.newark.com

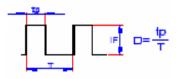


1W High Power LED





Duty Cycle:



Notes:

- 1. Proper current derating must de observed to maintain junction temperature below the maximum.
- 2. All products not sensitive to ESD damage (6000 Volts by HBM condition).
- 3. Be careful with powered up current limited power supply, because of current spikes during power up and/or connection. Best practice is to connect the LED then turn up the voltage gradually. People building their own power supplies should design for minimum current spikes during power up and connection.
- 4. For best results the customer needs to provide proper control of the thermal path, protect against electrical overstress conditions and ensure the emitters are properly attached to the mcpcb/heat sink.
- 5. It is recommended that the temperature of lead does not exceed 55 °C.
- 6. It is recommended to apply an electrically isolated heat conductive film between slug and contact surfaces.

Electrical & Optical Characteristics:

| Parameter | | Symbol Condition | Value | | | Unit | |
|-------------------------------------|---------|------------------|------------------------|------|------|------|--------------|
| | | | Condition | Min. | Тур. | Max. | Unit |
| | FULL | | | - | 84 | - | |
| Luminous Flux | Rank L1 | Φv ¹ | IF = 700 mA | 80 | - | 90 | lm |
| | Rank L2 | 1 | | 90 | - | 100 | |
| Forward Voltage | Rank V1 | VF | IF = 700 mA | 2.9 | - | 3.1 | |
| | Rank V2 | | | 3.1 | - | 3.3 | |
| | Rank V3 | | | 3.3 | - | 3.5 | V |
| | Rank V4 | | | 3.5 | - | 3.7 | |
| | Rank V5 | | | 3.7 | - | 3.9 | |
| Dominant Wavelength | | λd IF = 700 mA | IF 700 A | 515 | - | 520 | |
| | | | | 520 | - | 525 | |
| | | | $IF = 700 \mathrm{mA}$ | 525 | - | 530 | nm |
| | | | | 530 | - | 535 | |
| Reverse Current | | lr | Vr=5V | - | - | 50 | μΑ |
| View Angle at 50% IV | | 201/2 | IF=700 mA | - | 130 | - | deg |
| Thermal resistance Junction to Case | | РθЈ-с | IF=700 mA | - | 15 | - | ° C/W |

Notes: 1. The data is tested by an IS tester.

Customer's special requirements are also welcome.

Important Notice: This data sheet and its contents (the "Information") belong to the members of the Premier Farnell group of companies (the "Group") or are licensed to it. No licence is granted for the use of it other than for information purposes in connection with the products to which it relates. No licence of any intellectual property rights is granted. The Information is subject to change without notice and replaces all data sheets previously supplied. The Information supplied is believed to be accurate but the Group assumes no responsibility for its accuracy or completeness, any error in or omission from it or for any use made of it. Users of this data sheet should check for themselves the Information and the suitability of the products for their purpose and not make any assumptions based on information included or omitted. Liability for loss or damage resulting from any reliance on the Information or use of it (including liability resulting from negligence or where the Group was aware of the possibility of such loss or damage arising) is excluded. This will not operate to limit or restrict the Group's liability for death or personal injury resulting from its negligence. Multicomp is the registered trademark of the Group. © Premier Farnell plc 2011.

www.element14.com www.farnell.com www.newark.com







Typical Electrical / Optical Characteristic Curves:

(25°C Ambient Temperature unless otherwise noted)

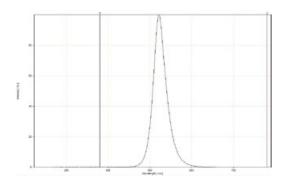
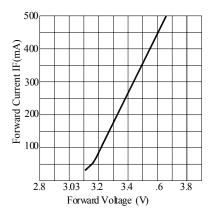
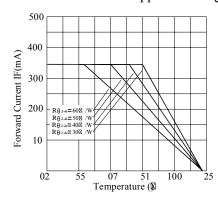


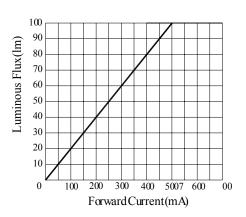
Fig.1 WHITE LED Spectrum VS. WAVELENGTH



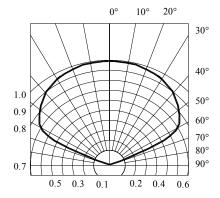
Forward Current VS. Applied Voltage



Ambient Temperature VS. Forward Current



Forward Current VS. Luminous Flux



Radiation Diagram

Important Notice: This data sheet and its contents (the "Information") belong to the members of the Premier Farnell group of companies (the "Group") or are licensed to it. No licence is granted for the use of it other than for information purposes in connection with the products to which it relates. No licence of any intellectual property rights is granted. The Information is subject to change without notice and replaces all data sheets previously supplied. The Information supplied is believed to be accurate but the Group assumes no responsibility for its accuracy or completeness, any error in or omission from it or for any use made of it. Users of this data sheet should check for themselves the Information and the suitability of the products for their purpose and not make any assumptions based on information included or omitted. Liability for loss or damage resulting from any reliance on the Information or use of it (including liability resulting from negligence or where the Group was aware of the possibility of such loss or damage arising) is excluded. This will not operate to limit or restrict the Group's liability for death or personal injury resulting from its negligence. Multicomp is the registered trademark of the Group. @ Premier Farnell plc 2011.



1W High Power LED





Storage:

Recommended storage environment:

- Temperature: 5°C ~ 30°C (41°F ~ 86°F)
- Humidity: 60% RH Max.
- Moisture measures: Please refer to Moisture-sensitive label on reels package bags. If unused LEDs remain, they should be stored in moisture proof packages, such as a sealed container with packages of moisture absorbant material (silica gel). It is also recommended to return the LEDs to the original moisture proof bag and to reseal it again (fold the open bag firmly shut and keep in a dry environment

Soldering:

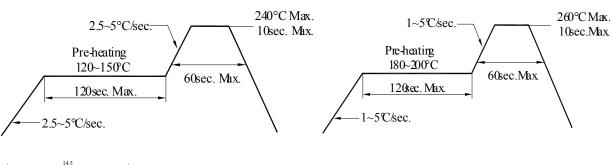
| Reflow Soldering | | | Ha | Hand Soldering | | |
|------------------|------------------------------------|------------------------------------|----------------|----------------------------|--|--|
| | Lead Solder | Lead-free Solder | | | | |
| Pre-heat | 120∼150°C | 180∼200°C | Temperature | 350°C Max. | | |
| Pre-heat Time | 120sec. Max. | 120sec. Max. | Soldering Time | | | |
| Peak Temperature | 240°C Max. | 260°C Max. | | | | |
| Soldering Time | 10sec. max. | 10sec. Max. | | 3sec. Max. (one time only) | | |
| Condition | Refer to Temperature- profile 1 | Refer to Temperature- profile 2 | | | | |

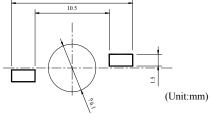
^{*} After reflow soldering rapid cooling should be avoided.

Temperature-profile (Surface of circuit board):

Use the following conditions shown in the figure.

<1 : Lead Solder> <2 : Lead-free Solder>





Important Notice: This data sheet and its contents (the "Information") belong to the members of the Premier Farnell group of companies (the "Group") or are licensed to it. No licence is granted for the use of it other than for information purposes in connection with the products to which it relates. No licence of any intellectual property rights is granted. The Information is subject to change without notice and replaces all data sheets previously supplied. The Information supplied is believed to be accurate but the Group assumes no responsibility for its accuracy or completeness, any error in or omission from it or for any use made of it. Users of this data sheet should check for themselves the Information and the suitability of the products for their purpose and not make any assumptions based on information included or omitted. Liability for loss or damage resulting from any reliance on the Information or use of it (including liability resulting from negligence or where the Group was aware of the possibility of such loss or damage arising) is excluded. This will not operate to limit or restrict the Group's liability for death or personal injury resulting from its negligence. Multicomp is the registered trademark of the Group. © Premier Farnell plc 2011.

www.element14.com www.farnell.com www.newark.com

